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# STL110N10F7

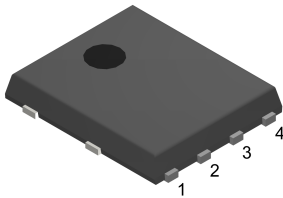
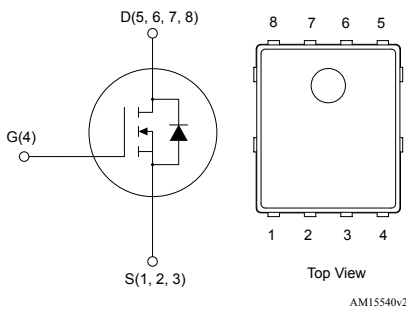
STMicroelectronics

MOSFET N-CH 100V 0.005Ohm 21A STripFET VII

Any questions, please feel free to contact us.

[info@kaimte.com](mailto:info@kaimte.com)

## N-channel 100 V, 5 mΩ typ., 107 A, STripFET F7 Power MOSFET in a PowerFLAT 5x6 package


**PowerFLAT 5x6**


### Features

Order code	$V_{DS}$	$R_{DS(on)}$ max.	$I_D$	$P_{TOT}$
STL110N10F7	100 V	6 mΩ	107 A	136 W

- Among the lowest  $R_{DS(on)}$  on the market
- Excellent FoM (figure of merit)
- Low  $C_{rSS}/C_{iSS}$  ratio for EMI immunity
- High avalanche ruggedness

### Applications

- Switching applications

### Description

This N-channel Power MOSFET utilizes STripFET F7 technology with an enhanced trench gate structure that results in very low on-state resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.



#### Product status link

[STL110N10F7](#)

#### Product summary

<b>Order code</b>	STL110N10F7
<b>Marking</b>	110N10F7
<b>Package</b>	PowerFLAT 5x6
<b>Packing</b>	Tape and reel

# 1 Electrical ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage	100	V
$V_{GS}$	Gate-source voltage	±20	V
$I_D^{(1)}$	Drain current (continuous) at $T_C = 25\text{ °C}$	107	A
	Drain current (continuous) at $T_C = 100\text{ °C}$	75	A
$I_{DM}^{(1)(2)}$	Drain current (pulsed)	428	A
$I_D^{(3)}$	Drain current (continuous) at $T_C = 25\text{ °C}$	21	A
	Drain current (continuous) at $T_C = 100\text{ °C}$	14	A
$I_{DM}^{(2)(3)}$	Drain current (pulsed)	84	A
$P_{TOT}^{(1)}$	Total power dissipation at $T_C = 25\text{ °C}$	136	W
$P_{TOT}^{(3)}$	Total power dissipation at $T_{pcb} = 25\text{ °C}$	4.8	W
$E_{AS}^{(4)}$	Single pulse avalanche energy	490	mJ
$T_J$	Operating junction temperature range	-55 to 175	°C
$T_{stg}$	Storage temperature range		

1. This value is rated according to  $R_{thj-c}$ .
2. Pulse width limited by safe operating area.
3. This value is rated according to  $R_{thj-pcb}$ .
4. Starting  $T_J = 25\text{ °C}$ ,  $I_D = 18\text{ A}$ ,  $V_{DD} = 50\text{ V}$ .

**Table 2. Thermal resistance**

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case	1.1	°C/W
$R_{thj-pcb}^{(1)}$	Thermal resistance junction-pcb	31.3	°C/W

1. When mounted on an FR-4 board of 1 inch<sup>2</sup>, 2oz Cu,  $t < 10\text{ s}$ .

## 2 Electrical characteristics

( $T_C = 25\text{ °C}$  unless otherwise specified)

**Table 3. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$	100			V
$I_{DSS}$	Zero gate voltage drain current	$V_{GS} = 0\text{ V}$ , $V_{DS} = 100\text{ V}$			1	$\mu\text{A}$
		$V_{GS} = 0\text{ V}$ , $V_{DS} = 100\text{ V}$ , $T_C = 125\text{ °C}^{(1)}$			10	
$I_{GSS}$	Gate body leakage current	$V_{DS} = 0$ , $V_{GS} = 20\text{ V}$			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$	2.5		4.5	V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 10\text{ V}$ , $I_D = 10\text{ A}$		5	6	m $\Omega$

1. Defined by design, not subject to production test.

**Table 4. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 50\text{ V}$ , $f = 1\text{ MHz}$ , $V_{GS} = 0\text{ V}$	-	5117	-	$\mu\text{F}$
$C_{oss}$	Output capacitance		-	992	-	
$C_{rss}$	Reverse transfer capacitance		-	39	-	
$Q_g$	Total gate charge	$V_{DD} = 50\text{ V}$ , $I_D = 21\text{ A}$ , $V_{GS} = 0\text{ to }10\text{ V}$ (see Figure 13. Test circuit for gate charge behavior)	-	72	-	nC
$Q_{gs}$	Gate-source charge		-	30	-	
$Q_{gd}$	Gate-drain charge		-	17	-	

**Table 5. Switching times**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 50\text{ V}$ , $I_D = 10\text{ A}$ , $R_G = 4.7\text{ }\Omega$ , $V_{GS} = 10\text{ V}$ (see Figure 12. Test circuit for resistive load switching times and Figure 17. Switching time waveform)	-	25	-	ns
$t_r$	Rise time		-	36	-	ns
$t_{d(off)}$	Turn-off delay time		-	52	-	ns
$t_f$	Fall time		-	21	-	ns

**Table 6. Source-drain diode**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{SD}^{(1)}$	Forward on voltage	$I_{SD} = 21\text{ A}$ , $V_{GS} = 0\text{ V}$	-		1.2	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 21\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ , $V_{DD} = 80\text{ V}$ , $T_J = 150\text{ °C}$ (see Figure 14. Test circuit for inductive load switching and diode recovery times)	-	77		ns
$Q_{rr}$	Reverse recovery charge		-	150		nC
$I_{RRM}$	Reverse recovery current		-	4.3		A

1. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%.

## 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

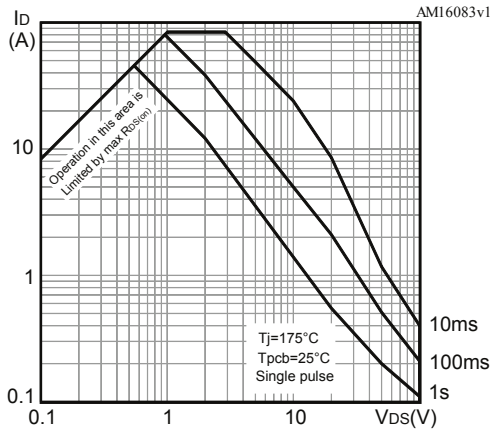


Figure 2. Thermal impedance

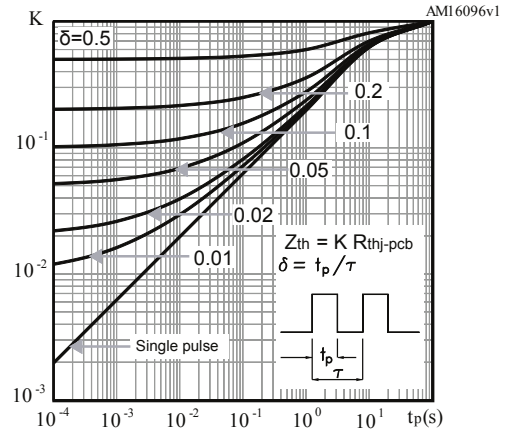


Figure 3. Output characteristics

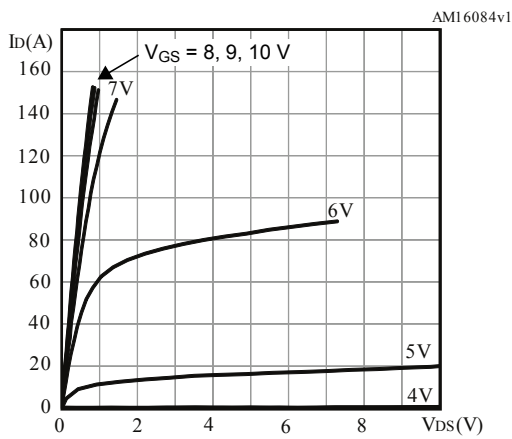


Figure 4. Transfer characteristics

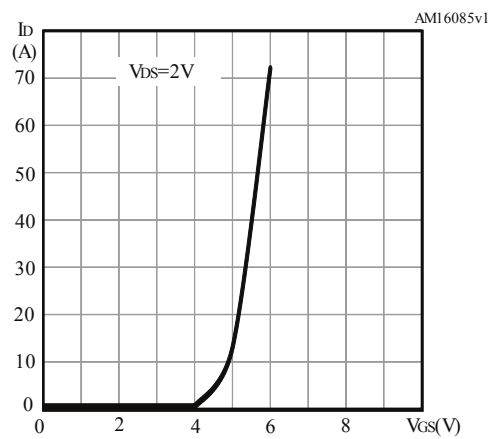


Figure 5. Gate charge vs gate-source voltage

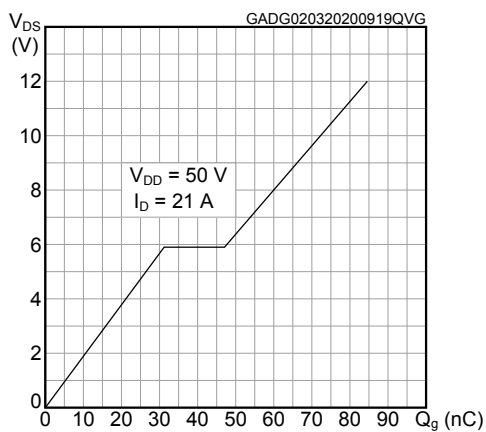


Figure 6. Static drain-source on-resistance

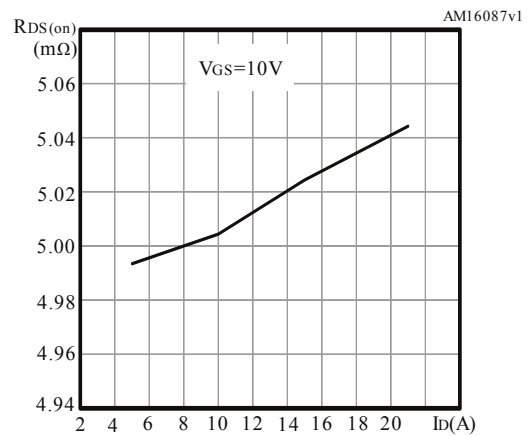


Figure 7. Capacitance variations

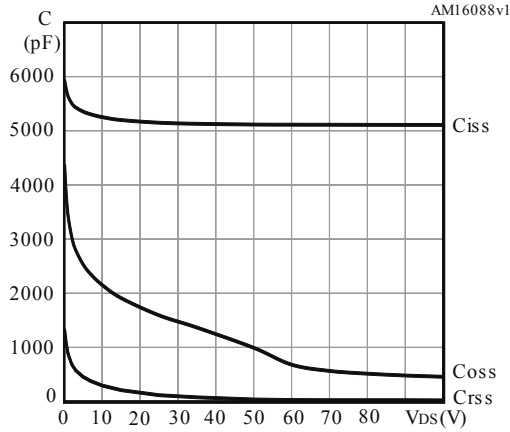


Figure 8. Normalized gate threshold voltage vs temperature

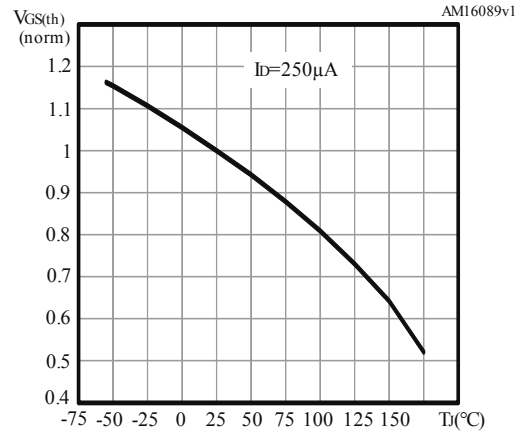


Figure 9. Normalized on-resistance vs temperature

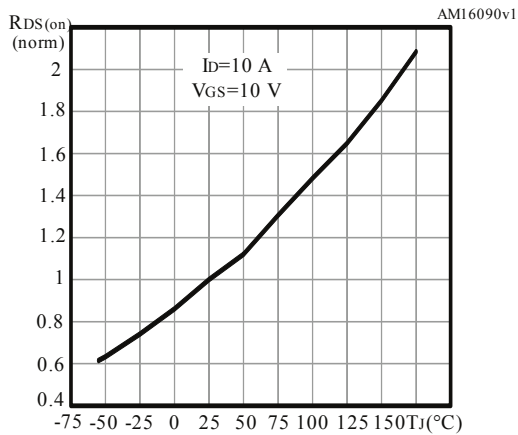


Figure 10. Source-drain diode forward characteristics

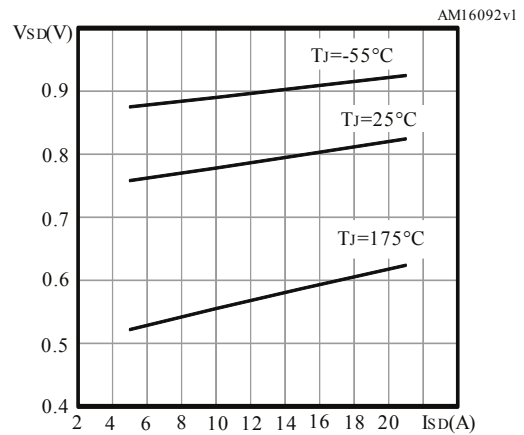
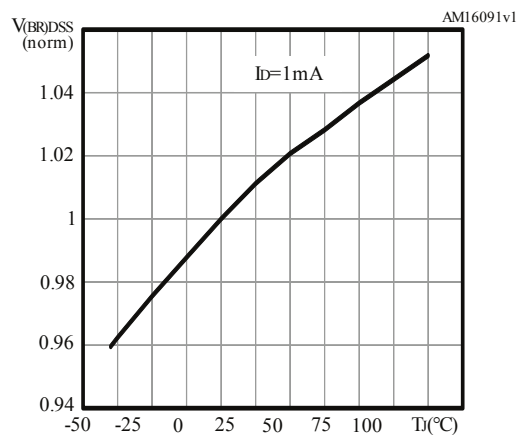
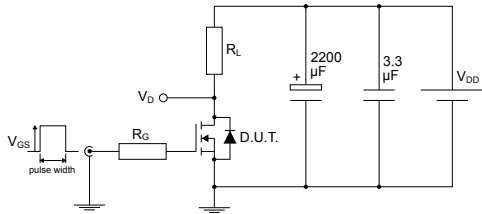


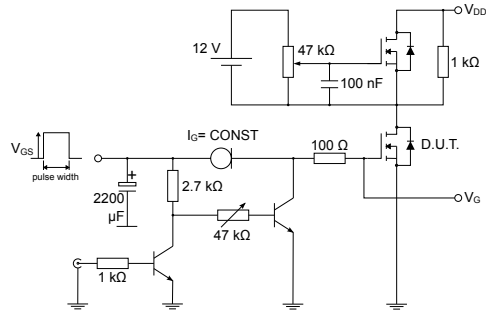
Figure 11. Normalized V<sub>(BR)DSS</sub> vs temperature



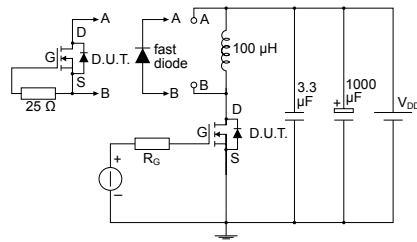
### 3 Test circuits

**Figure 12. Test circuit for resistive load switching times**


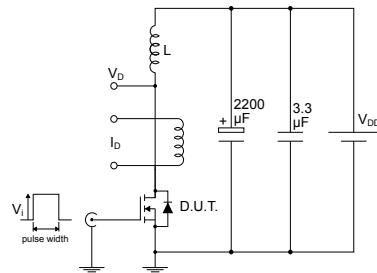
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**Figure 13. Test circuit for gate charge behavior**


AM01469v1

**Figure 14. Test circuit for inductive load switching and diode recovery times**


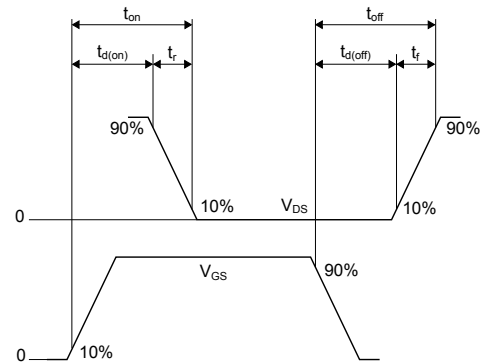
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**Figure 15. Unclamped inductive load test circuit**


AM01471v1

**Figure 16. Unclamped inductive waveform**


AM01472v1

**Figure 17. Switching time waveform**


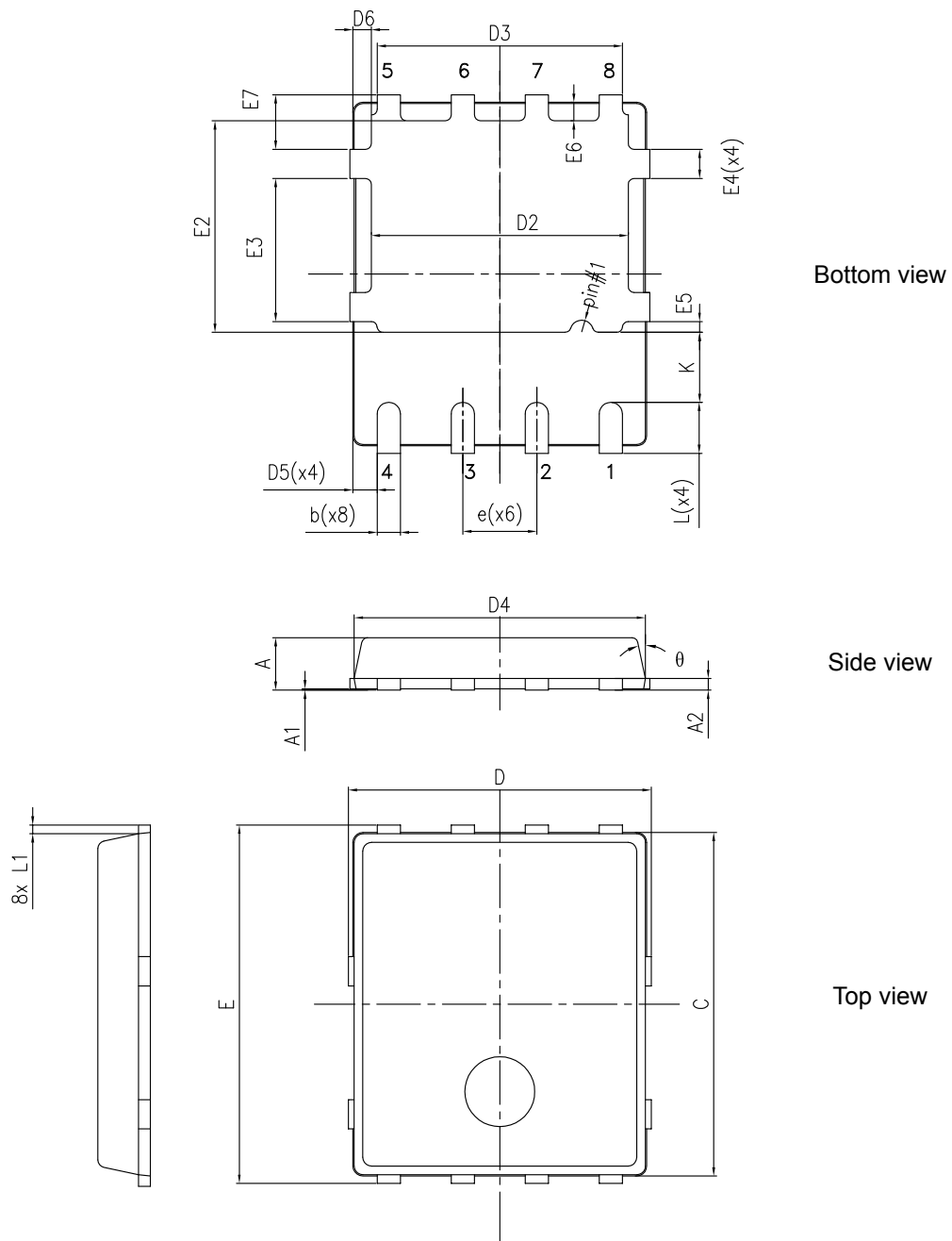
AM01473v1

## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

### 4.1 PowerFLAT 5x6 type C package information

Figure 18. PowerFLAT 5x6 type C package outline



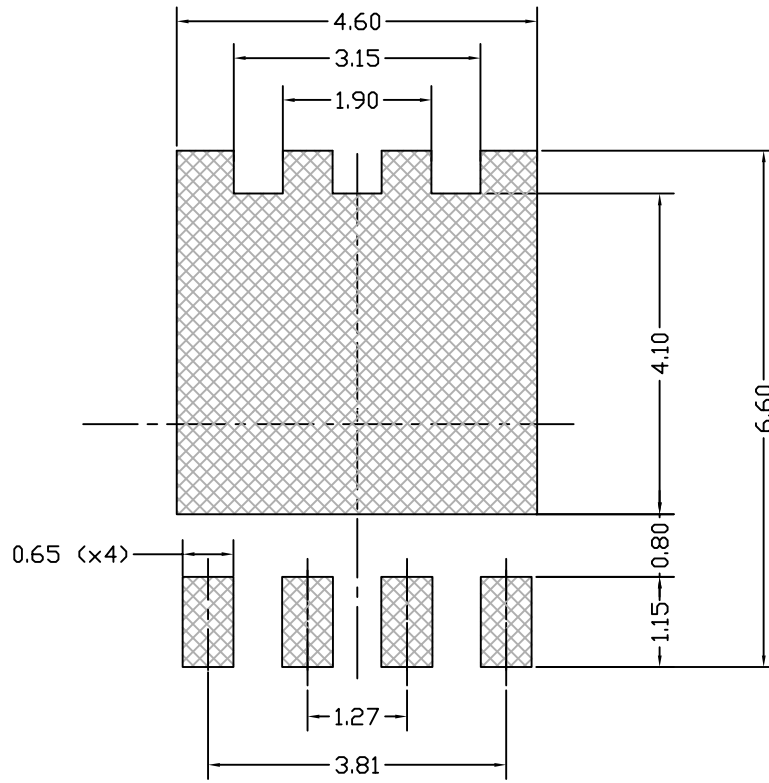
8231817\_typeC\_Rev20



**Table 7. PowerFLAT 5x6 type C package mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A	0.80		1.00
A1	0.02		0.05
A2		0.25	
b	0.30		0.50
C	5.80	6.00	6.20
D	5.00	5.20	5.40
D2	4.15		4.45
D3	4.05	4.20	4.35
D4	4.80	5.00	5.20
D5	0.25	0.40	0.55
D6	0.15	0.30	0.45
e		1.27	
E	5.95	6.15	6.35
E2	3.50		3.70
E3	2.35		2.55
E4	0.40		0.60
E5	0.08		0.28
E6	0.20	0.325	0.45
E7	0.75	0.90	1.05
K	1.05		1.35
L	0.725		1.025
L1	0.05	0.15	0.25
θ	0°		12°

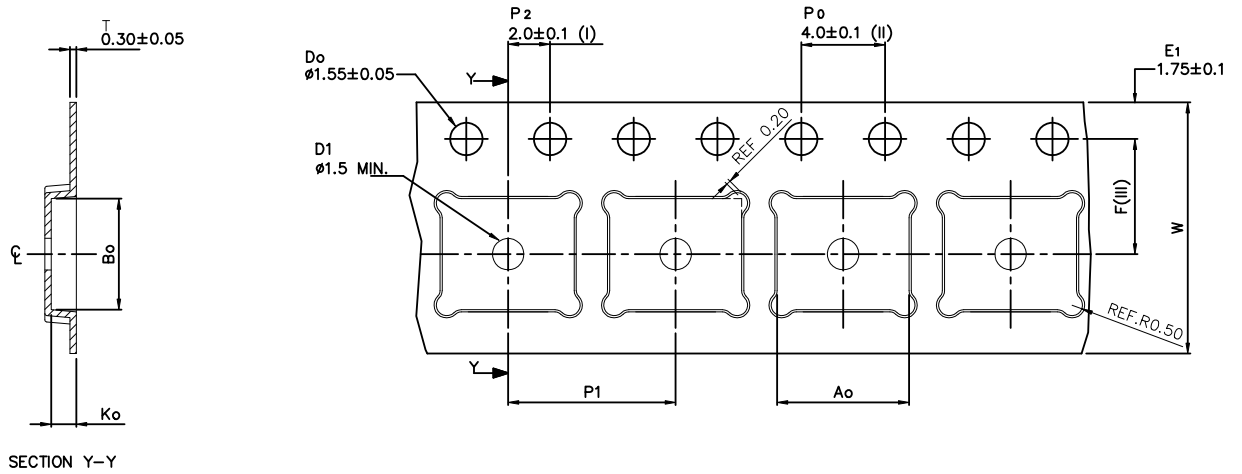
Figure 19. PowerFLAT 5x6 recommended footprint (dimensions are in mm)



8231817\_FOOTPRINT\_simp\_Rev\_20

## 4.2 PowerFLAT 5x6 packing information

Figure 20. PowerFLAT 5x6 tape (dimensions are in mm)



$A_0$	6.30	+/- 0.1
$B_0$	5.30	+/- 0.1
$K_0$	1.20	+/- 0.1
$F$	5.50	+/- 0.1
$P_1$	8.00	+/- 0.1
$W$	12.00	+/- 0.3

(I) Measured from centreline of sprocket hole to centreline of pocket.

(II) Cumulative tolerance of 10 sprocket holes is  $\pm 0.20$ .

(III) Measured from centreline of sprocket hole to centreline of pocket

Base and bulk quantity 3000 pcs  
All dimensions are in millimeters

8234350\_Tape\_rev\_C

Figure 21. PowerFLAT 5x6 package orientation in carrier tape

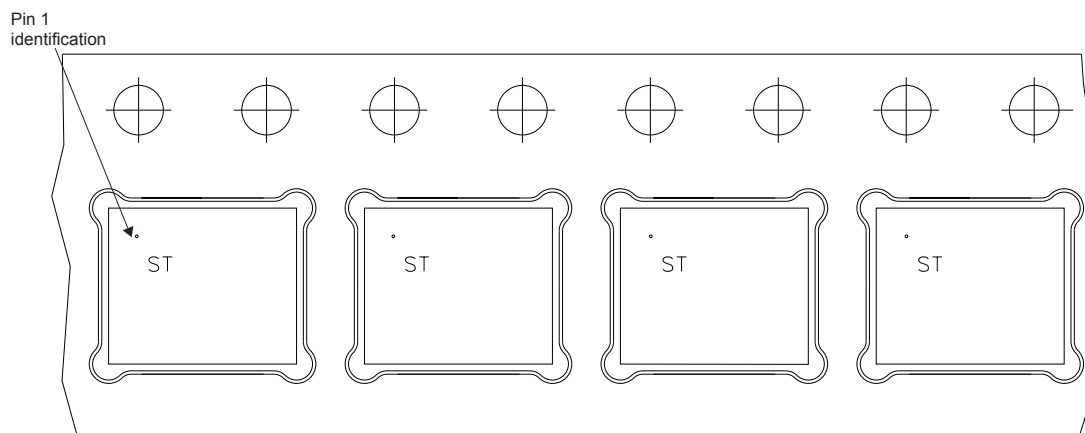
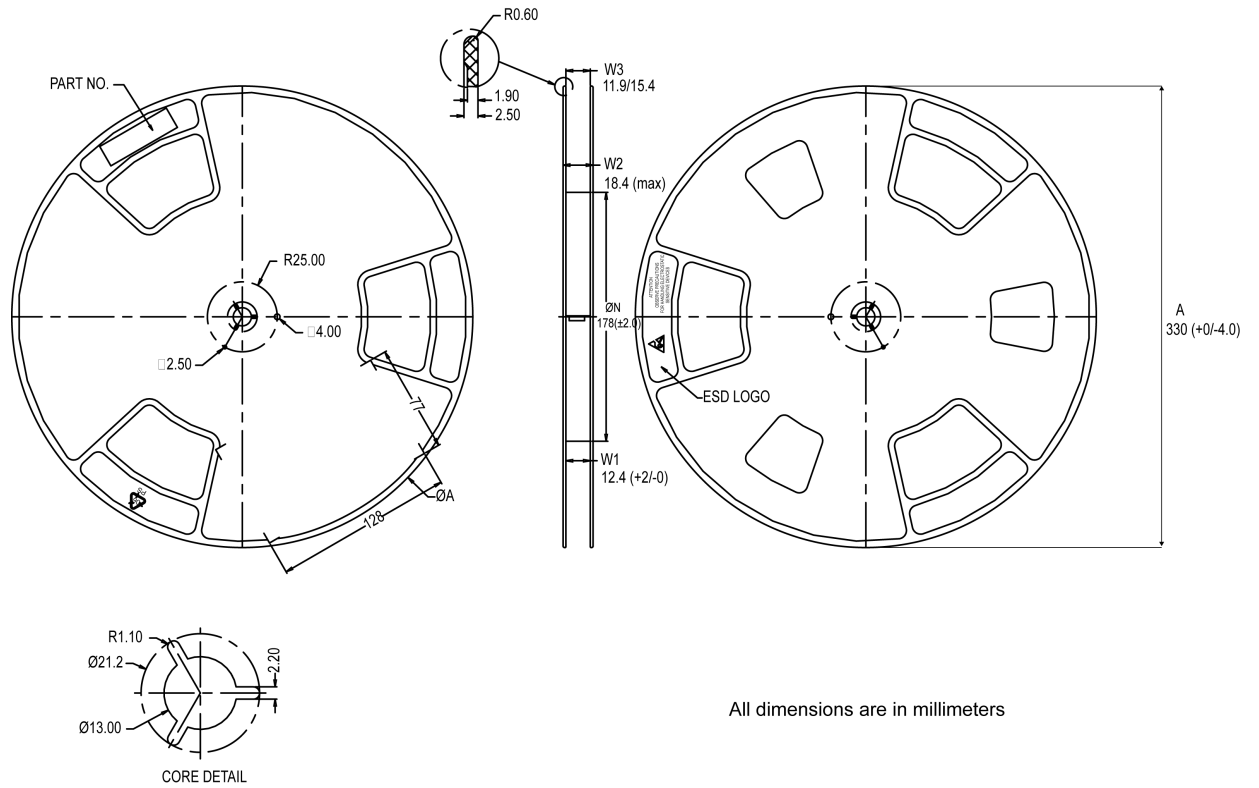


Figure 22. PowerFLAT 5x6 reel



All dimensions are in millimeters

8234350\_Reel\_rev\_C

## Revision history

**Table 8. Document revision history**

Date	Revision	Changes
03-Dec-2012	1	First release.
12-Dec-2013	2	Modified: $P_{TOT}$ value and <i>Figure 1</i> in cover page Modified: $I_D$ , $I_{DM}$ and $P_{TOT}$ values in <i>Table 2</i> Added: $E_{AS}$ value in <i>Table 2</i> Modified: all values in <i>Table 3</i> Modified: $I_{DSS}$ , $I_{GSS}$ and $I_D$ for $R_{DS(on)}$ Updated: the entire typical values in <i>Table 5</i> , <i>6</i> and <i>7</i> Updated: <i>Figure 13</i> , <i>14</i> , <i>15</i> and <i>16</i> Minor text changes
25-Mar-2014	3	Updated title and features on cover page. Added $P_{TOT}$ value at $T_C = 25\text{ °C}$ in <i>Table 2: Absolute maximum ratings</i> . Updated <i>Section 4: Package mechanical data</i> .
20-Aug-2014	4	Modified: title, features and description Modified: <i>Figure 2</i> and <i>3</i> Updated: <i>Section 4: Package mechanical data</i> . Minor text changes
17-Sep-2018	5	Removed maturity status indication. Updated title and description on cover page. Updated <i>Table 1. Absolute maximum ratings</i> and <i>Table 6. Source-drain diode</i> . Updated <i>Section 4.1 PowerFLAT™ 5x6 type C package information</i> . Minor text changes
03-Mar-2020	6	Updated <i>Figure 5. Gate charge vs gate-source voltage</i> . Minor text changes.

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